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Davis et al.

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(54) **ELECTRONIC DEVICE CASE**

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(**) Term: **15 Years**

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(51) **LOC (14) Cl.** **14-02**

(52) **U.S. Cl.**
USPC **D14/440**

(58) **Field of Classification Search**
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D14/389, 392, 440, 444, 445, 446, 250;
D19/26, 62; D3/247, 290, 299, 206
CPC A45C 2011/002; A45C 2011/003; A45C
2200/15; A45F 2200/0516; A45F
2200/525; G06F 1/1628; G06F 1/1632;
G06F 1/1669; G06F 2200/1633; H04B
1/3888; H04M 1/185
See application file for complete search history.

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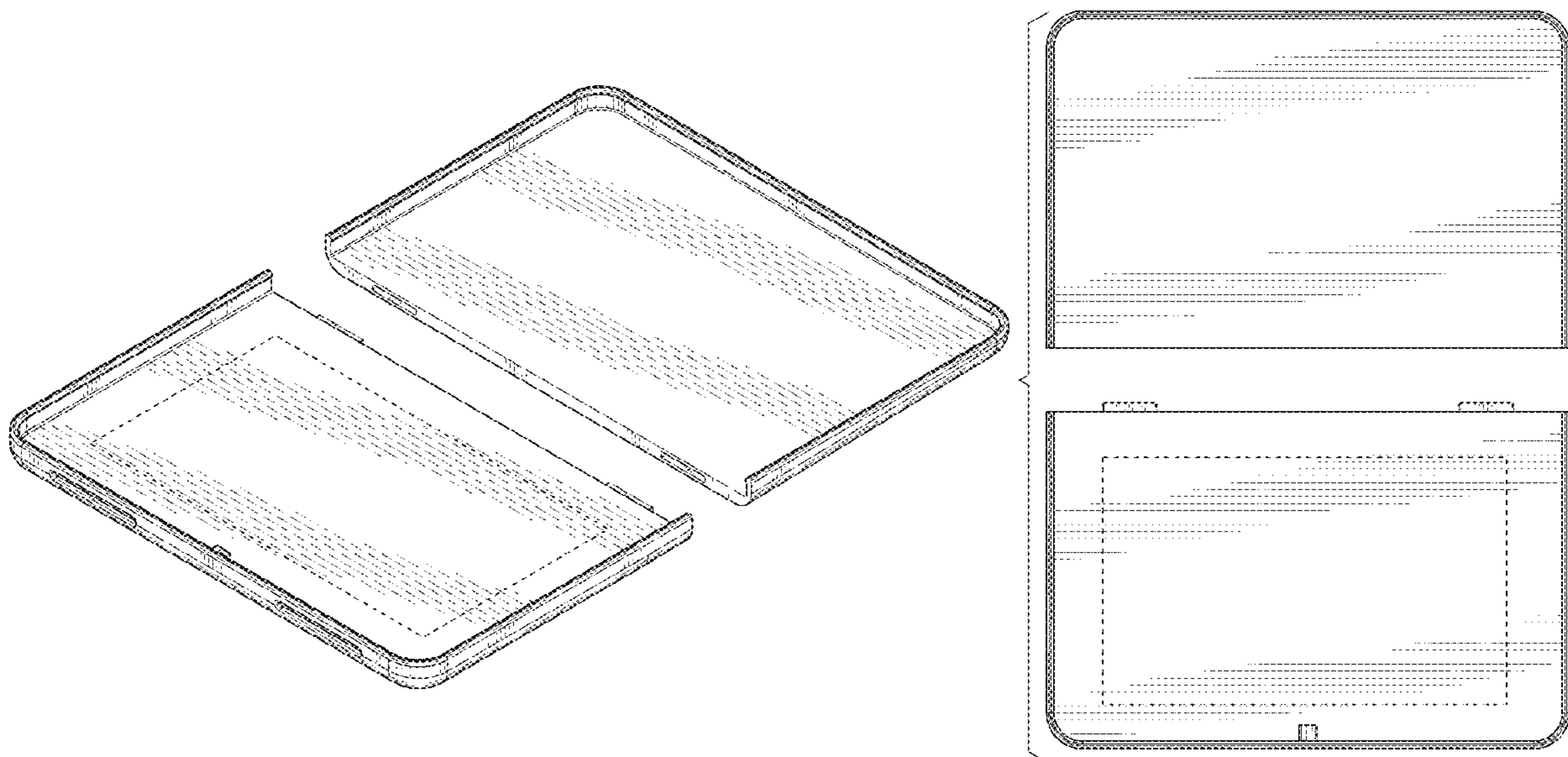
(57) **CLAIM**

The ornamental design for an electronics device case, as shown and described.

DESCRIPTION

FIG. 1 is an exploded top front right perspective view of the electronic device case, showing our new design; FIG. 2 is an exploded top plan view thereof; FIG. 3 is an exploded bottom plan view thereof; FIG. 4 is an exploded left side elevation view thereof; FIG. 5 is an exploded right side elevation view thereof; FIG. 6 is a front elevation view thereof; FIG. 7 is a rear elevation view thereof; and, FIG. 8 is another top front right perspective view thereof, showing the electronic device case assembled. The broken lines shown in the figures depict portions of the electronic device case that form no part of the claimed design.

1 Claim, 4 Drawing Sheets



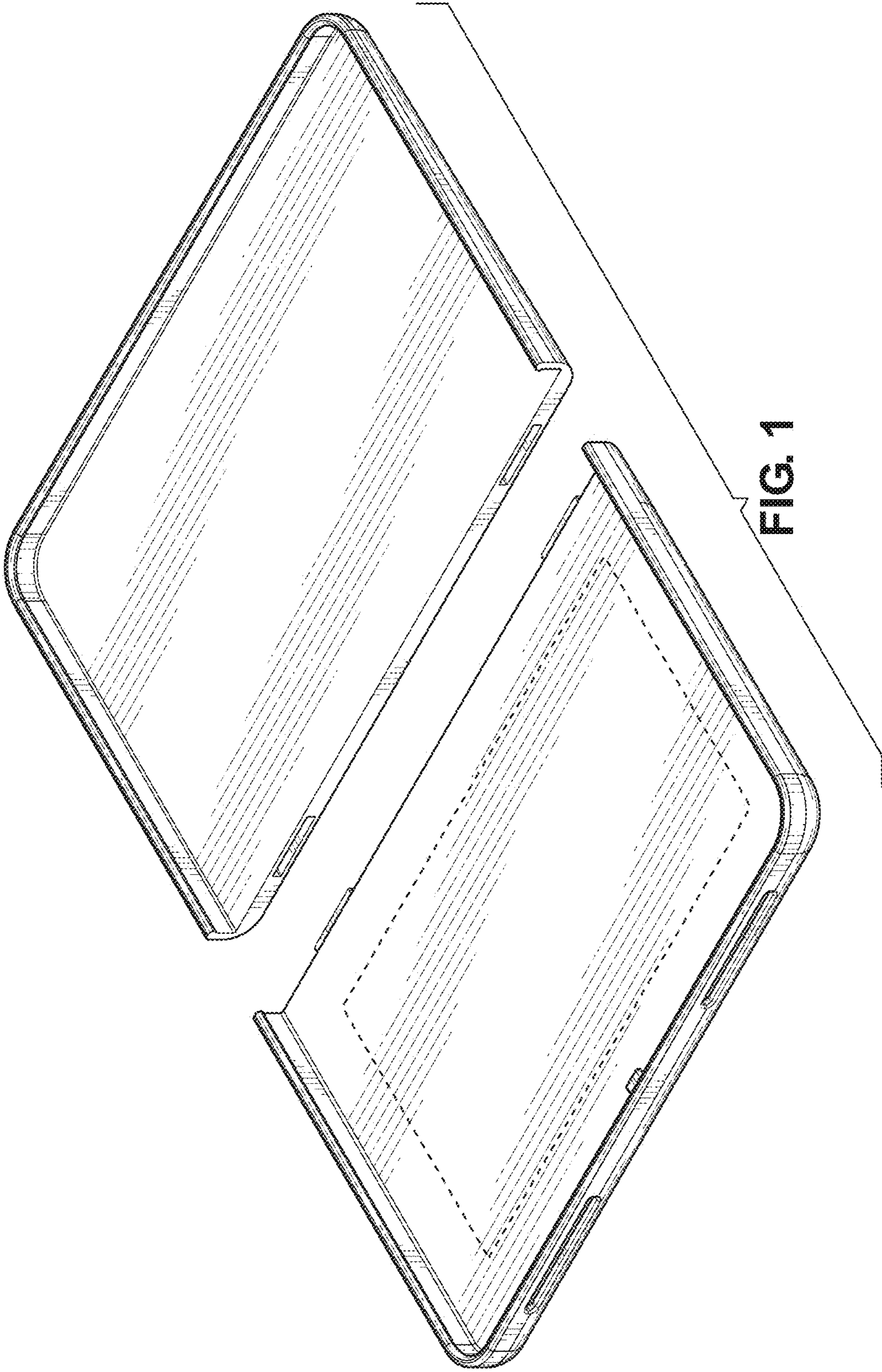


FIG. 1

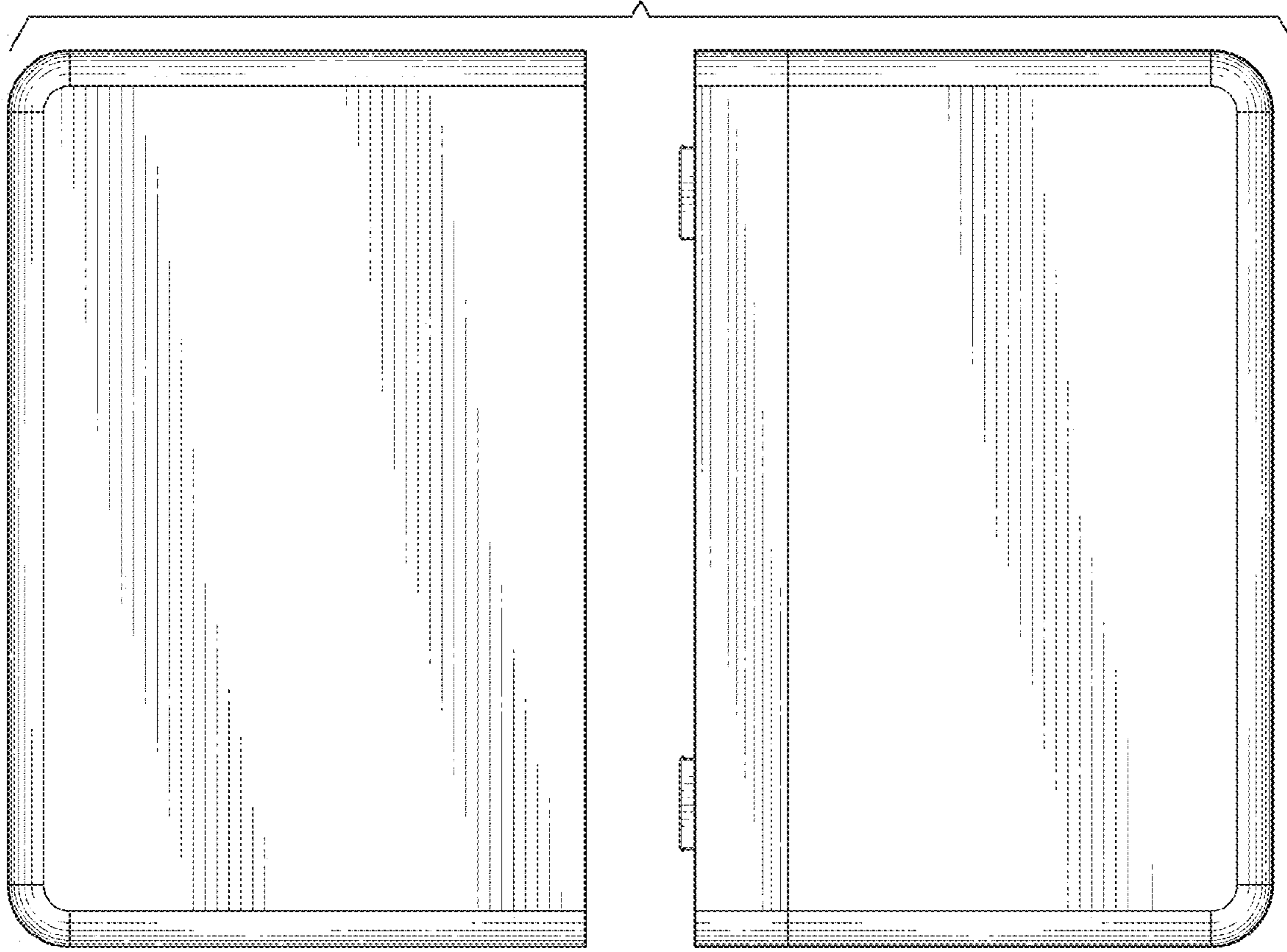


FIG. 3

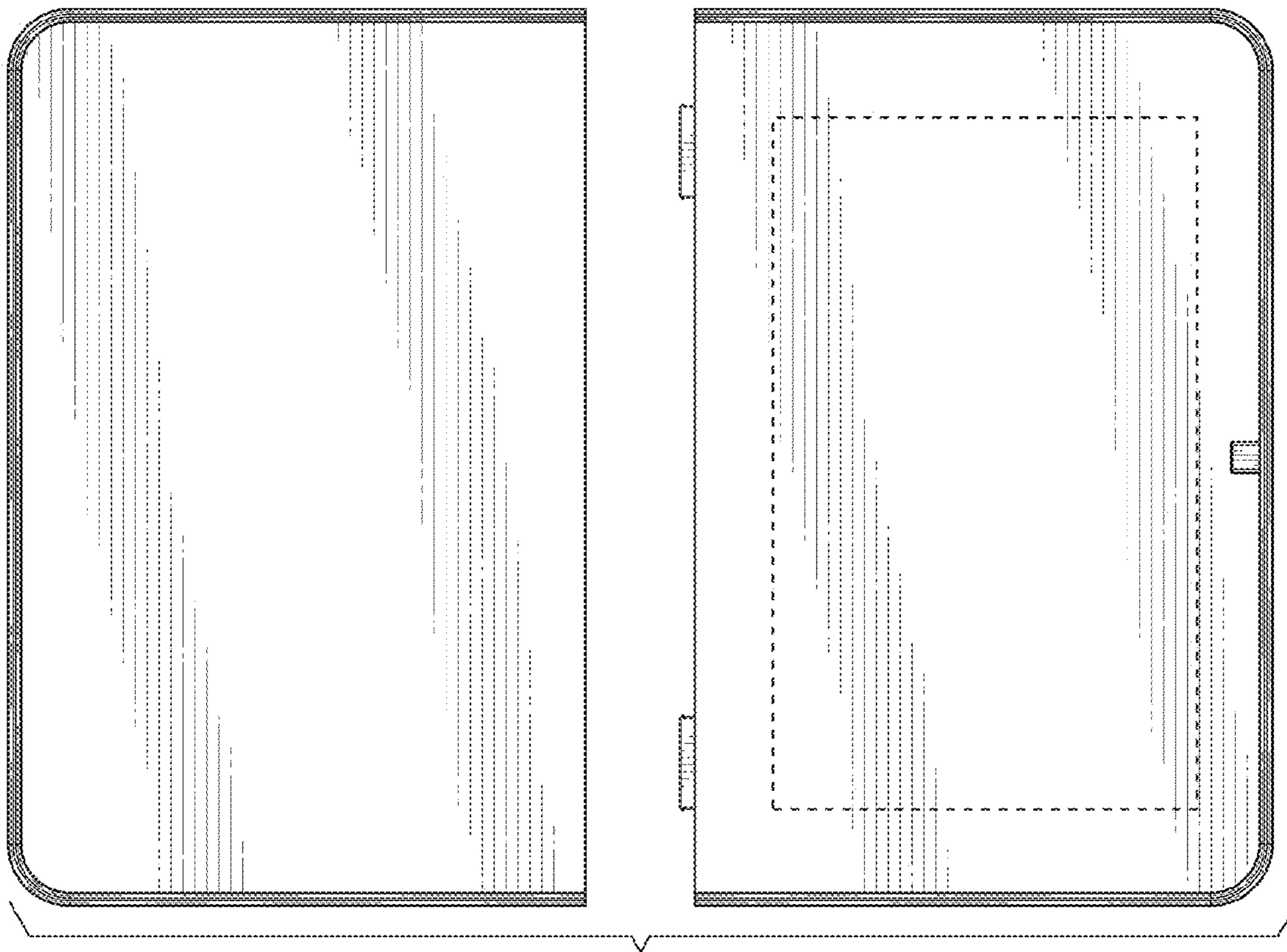


FIG. 2

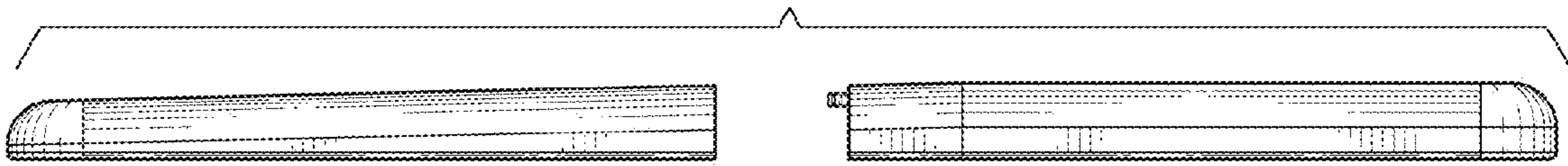


FIG. 5



FIG. 4

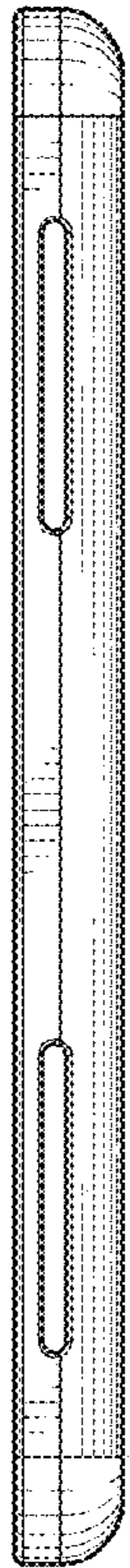


FIG. 6

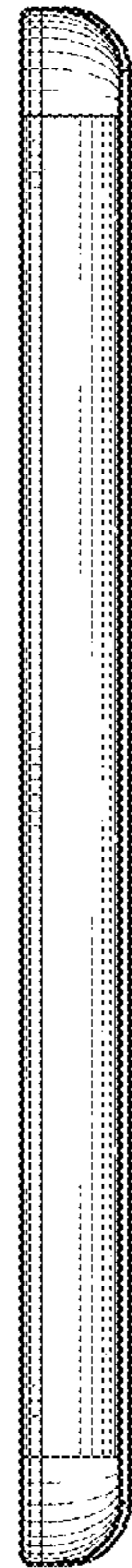


FIG. 7

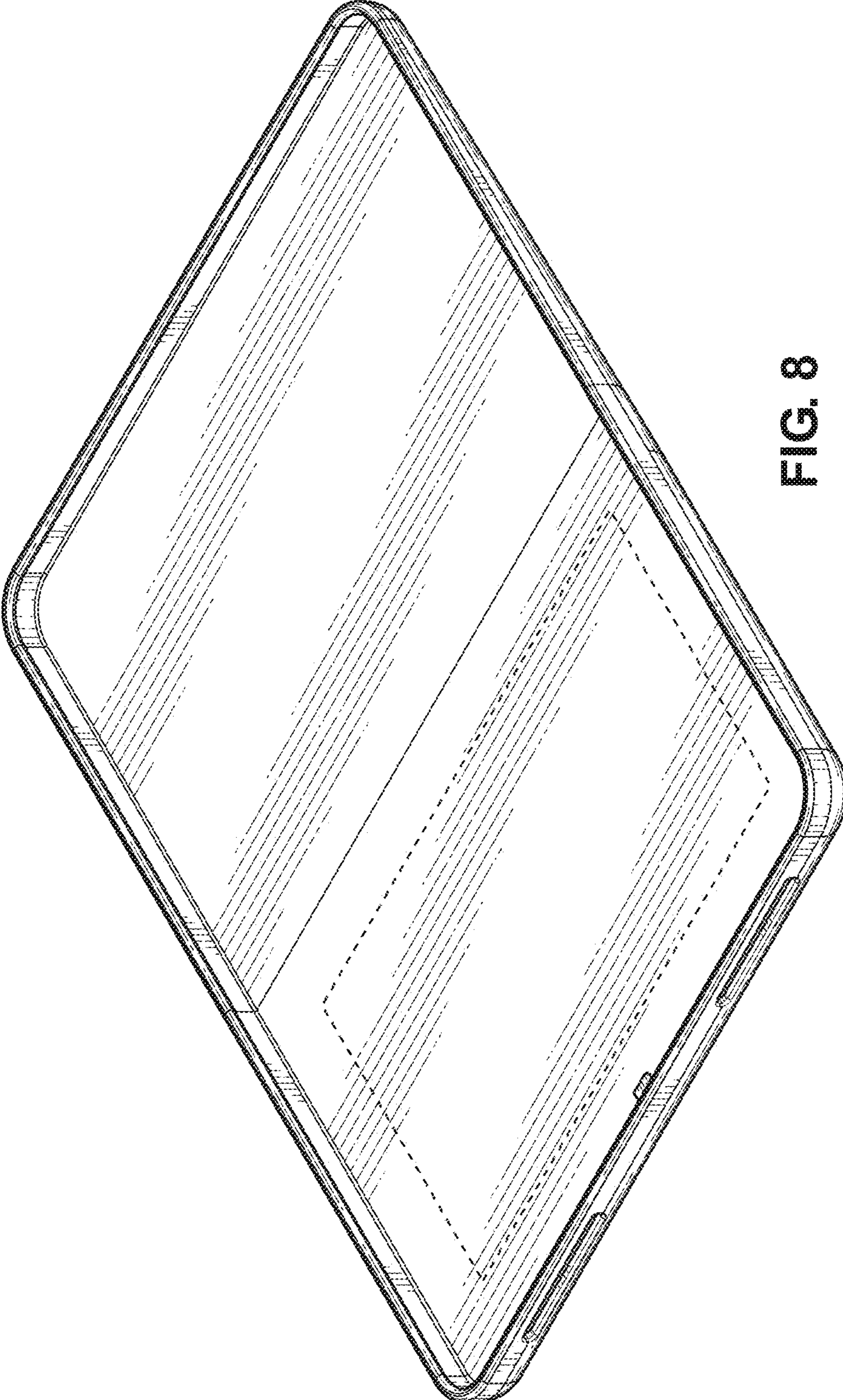


FIG. 8